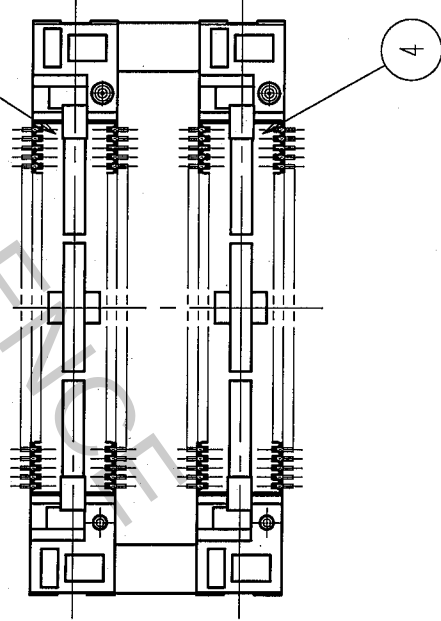
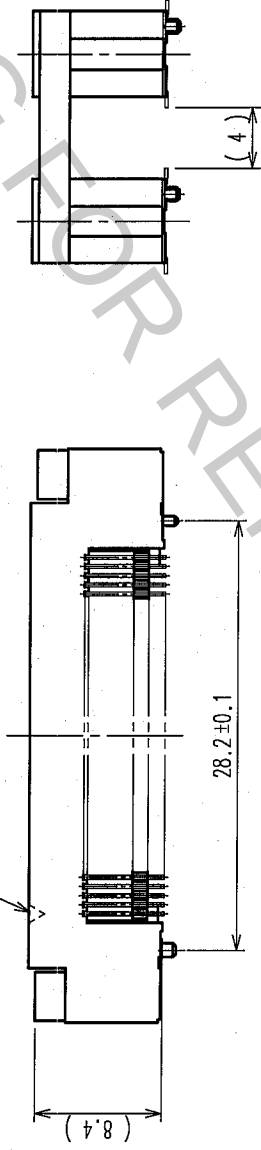
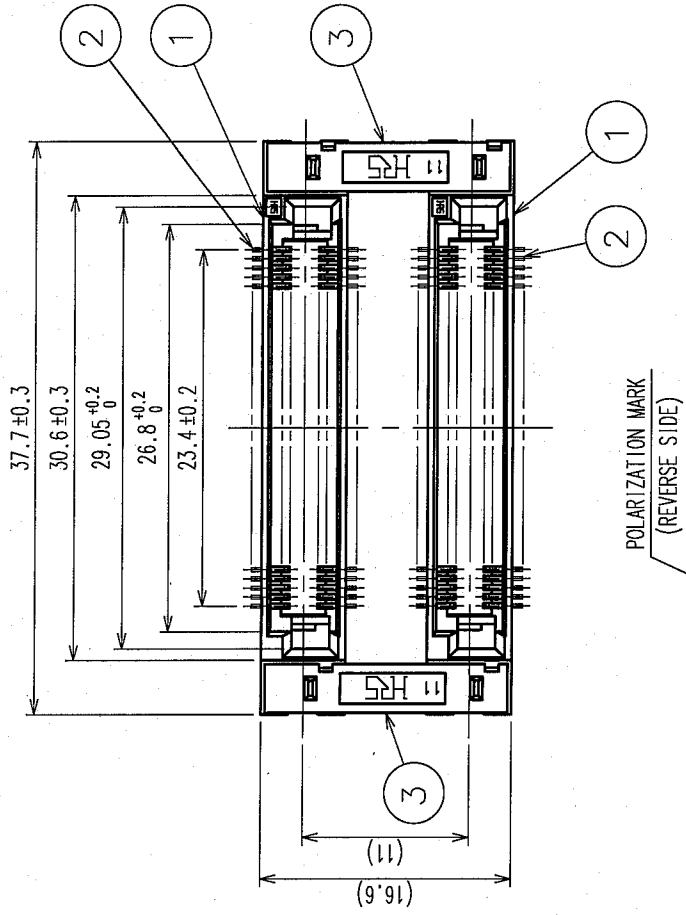
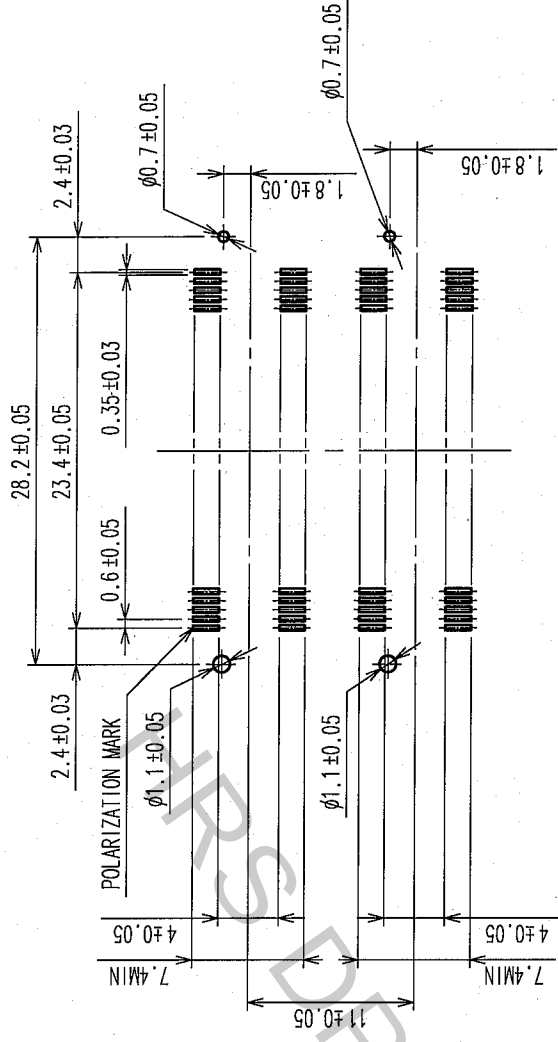


In case that the application demands a high level of reliability, such as automotive, please contact a company representative for further information.

DESCRIPTION OF REVISIONS		BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE



RECOMMENDED LAND PATTERN DIMENSION
OF PCB (MOUNTING SIDE)



- NOTES
- 1 LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
 - 2 AFTER MOUNTING BOARD, REF. NO. 3 SHALL BE REMOVED.
 - 3 FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED DEPENDS ON CIRCUMSTANCES.
 - 4 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

1,3,4	PPS	LIGHT BROWN (UL94V-0)	2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1μm min. LEAD AREA: TIN-PLATING 1μm min. UNDER PLATING: NICKEL 1μm min.			
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS			
CODE NO. (OLD) CL		DRAWN A. SUZUKAWA	DESIGNED H. Nakamura	CHECKED H. Nakamura	APPROVED H. Nakamura	RELEASED		
SCALE 2 : 1		DRAWING NO. EDC3-150972-25		PART NO. FX8C-80/80S11-SV5J(71)				
UNITS mm		CODE NO. CL578-0923-0-71						

